

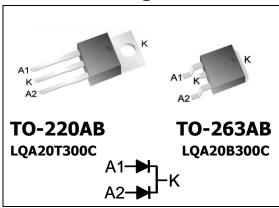
# **LQA20T300C, LQA20B300C Qspeed**<sup>™</sup> Family

300 V, 20 A Q-Series Common-Cathode Diode

### **Product Summary**

I <sub>F(AVG)</sub> per diode	10	Α
$V_{RRM}$	300	٧
Q <sub>RR</sub> (Typ at 125 °C)	38	nC
I <sub>RRM</sub> (Typ at 125 °C)	2.3	Α
Softness t <sub>b</sub> /t <sub>a</sub> (Typ at 125 °C)	0.7	

### **Pin Assignment**



### **RoHS Compliant**

Package uses Lead-free plating and Green mold compound, Halogen free per IEC 61249-2-21.

### **General Description**

This device has the lowest  $Q_{RR}$  of any 300 V Silicon diode. Its recovery characteristics increase efficiency, reduce EMI and eliminate snubbers.

### **Applications**

- AC/DC and DC/DC output rectification
  - Output & freewheeling diodes
- · Motor drive circuits
- DC-AC inverters

#### **Features**

- Low Q<sub>RR</sub>, low I<sub>RRM</sub>, low t<sub>RR</sub>
- High dI<sub>F</sub>/dt capable (1000A/µs)
- Soft recovery

#### **Benefits**

- Increases efficiency
  - Eliminates need for snubber circuits
  - Reduces EMI filter component size & count
- · Enables extremely fast switching

### **Absolute Maximum Ratings**

Absolute maximum ratings are the values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Symbol	Parameter	Conditions	Rating	Units
$V_{RRM}$	Peak repetitive reverse voltage		300	V
$I_{F(AVG)}$	Average forward current	Per Diode, $T_J = 150$ °C, $T_C = 115$ °C	10	Α
		Per Device, $T_J = 150$ °C, $T_C = 115$ °C	20	Α
$I_{FSM}$	Non-repetitive peak surge current	60 Hz, ½ cycle	80	Α
$I_{FSM}$	Non-repetitive peak surge current	$1/2$ cycle of t = 28 $\mu$ s Sinusoid, $T_C$ = 25 °C	350	Α
T <sub>J</sub>	Maximum junction temperature		150	°C
T <sub>STG</sub>	Storage temperature		-55 to 150	°C
	Lead soldering temperature	Leads at 1.6 mm from case, 10 sec	300	°C
$P_D$	Power dissipation	T <sub>C</sub> = 25 °C	52	W

www.power.com November 2015

#### **Thermal Resistance**

Symbol	Resistance from:	Conditions	Rating	Units
$R_{\theta JA}$	Junction to ambient	TO-220AB (only)	62	°C/W
D	Tunction to coop	Per Diode	2.4	°C/W
$R_{\theta JC}$	Junction to case	Per Device	1.2	°C/W

Electrical Specifications at  $T_1 = 25$  °C (unless otherwise specified)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
DC Chara	DC Characteristics per diode						
т	Dovorce current per diede	$V_R = 300 \text{ V}, T_J = 25 \text{ G}$	.C	-	-	25	μΑ
$I_{R}$	Reverse current per diode	$V_R = 300 \text{ V}, T_J = 125$	°C	-	0.32	-	mA
M	Face and called a control of	I <sub>F</sub> = 10 A, T <sub>J</sub> = 25 °C		-	1.58	1.9	V
$V_{F}$	Forward voltage per diode	I <sub>F</sub> = 10 A, T <sub>J</sub> = 150 °	С	-	1.36	-	V
C <sub>J</sub>	Junction capacitance per diode	V <sub>R</sub> = 10 V, 1 MHz		-	33	-	pF
Dynamic	Characteristics per diod	e		-	-	-	-
+	Reverse recovery time, per	$dI_F/dt = 200 A/\mu s$	T <sub>J</sub> = 25 °C	-	12.6	-	ns
t <sub>RR</sub>	diode	$V_R = 200, I_F = 10 A$	T <sub>J</sub> = 125 °C	-	24	-	ns
0	Reverse recovery charge,	$dI_F/dt = 200 A/\mu s$	T <sub>J</sub> = 25 °C	-	10.2	16	nC
$Q_{RR}$	per diode	$V_R = 200, I_F = 10 A$	T <sub>J</sub> = 125 °C	-	38	-	nC
т	Maximum reverse recovery	$dI_F/dt = 200 A/\mu s$	T <sub>J</sub> = 25 °C	-	1.3	1.7	Α
$I_{RRM}$	current, per diode	$V_R = 200, I_F = 10 A$	T <sub>J</sub> = 125 °C	-	2.3	-	Α
S	Softness per diode = $\frac{t_{\rm B}}{t_{\rm A}}$	$dI_F/dt = 200 A/\mu s$	T <sub>J</sub> = 25 °C	-	0.7	-	
		$V_R = 200, I_F = 10 A$	T₃ = 125 °C	-	0.7	_	

**Note to component engineers**: Q-Series diodes employ Schottky technologies in their design and construction. Therefore, component engineers should plan their test setups to be similar to traditional Schottky test setups. (For further details, see application note AN-300.)

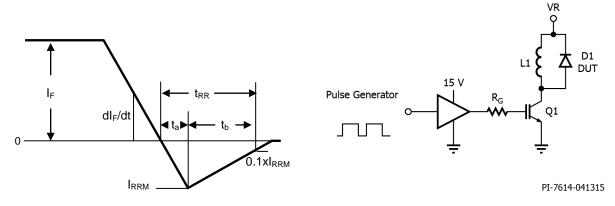
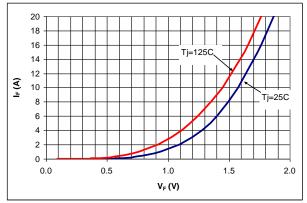


Figure 1. Reverse Recovery Definitions.

Figure 2. Reverse Recovery Test Circuit.

### Electrical Specifications at $T_1 = 25$ °C (unless otherwise specified)



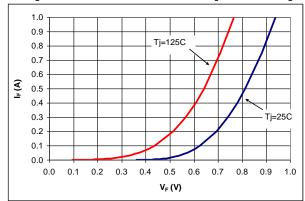
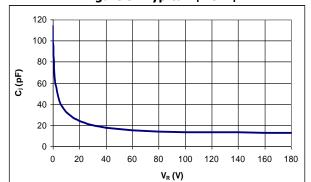


Figure 3. Typical  $I_F$  vs.  $V_F$ 



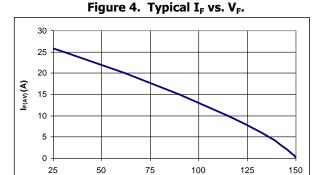


Figure 5. Typical C<sub>i</sub> vs. V<sub>R</sub>.

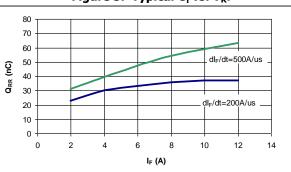


Figure 6. DC Current Derating Curve.

Case Temperature, T<sub>C</sub> (°C)

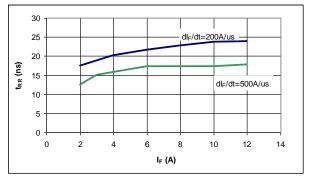
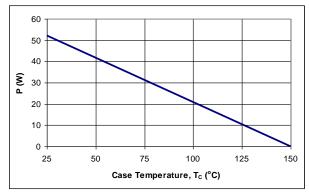


Figure 7. Typical  $Q_{RR}$  vs.  $I_F$  at  $T_j$  = 125 °C.

Figure 8. Typical tRR vs. IF at Tj = 125 °C.

#### LQA20T300C, LQA20B300C





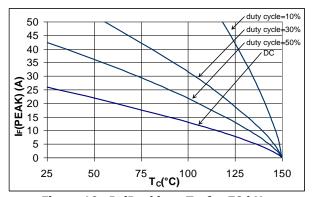
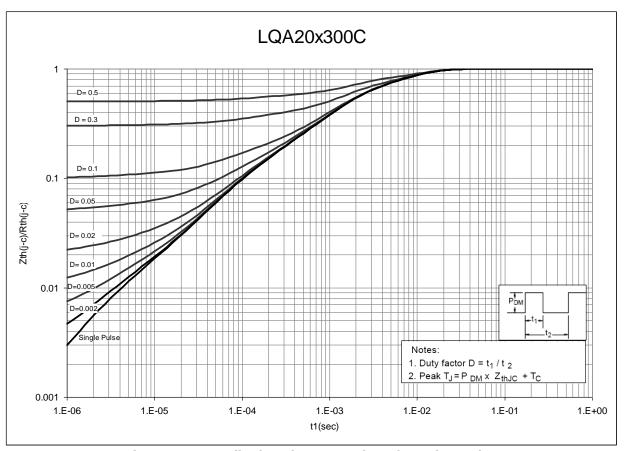


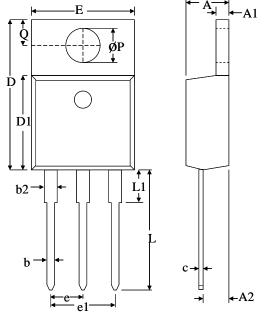
Figure 10.  $I_F$  (Peak) vs.  $T_{C_f}$  f = 70 kHz.



**Figure 11. Normalized Maximum Transient Thermal Impedance.** 

# **Dimensional Outline Drawings**

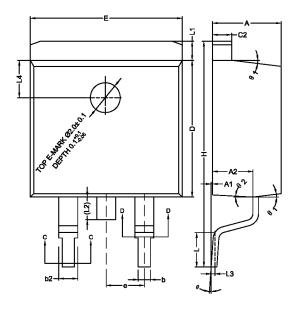
TO-220AB



	Millimeters		
Dim	MIN	MAX	
A	4.32	4.70	
<b>A1</b>	1.11	1.38	
A2	2.59	2.79	
b	0.77	1.00	
b2	1.23	1.36	
С	0.34	0.47	
D	14.71	15.75	
D1	9.05	9.25	
E	9.96	10.36	
е	2.44	2.64	
e1	4.98	5.18	
L	12.70	14.22	
L1	_	3.90	
ØP	3.71	3.96	
Q	2.54 2.90		

#### LQA20T300C, LQA20B300C

#### TO-263AB

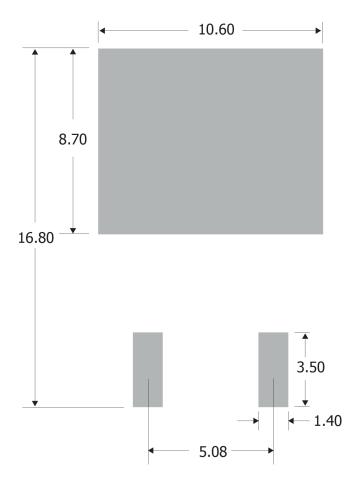


	Millimeters			
Dim	MIN	MAX		
Α	4.40	4.70		
<b>A1</b>	0.00	0.25		
A2	2.59	2.79		
b	0.77	0.90		
b2	1.23	1.36		
c2	1.22	1.32		
D	9.05	9.25		
E	10.06	10.26		
е	2.54 BSC	2.54 BSC		
Н	14.70	15.50		
L	2.00	2.60		
L1	1.17	1.40		
L2	-	1.75		
L3	0.25 BSC	0.25 BSC		
L4	2.00 BSC	2.00 BSC		
Θ	0°	8°		
Θ1	5°	9°		
Θ2	1°	5°		

Mechanical Mounting Method	Maximum Torque / Pressure specification
Screw through hole in package tab	1 Newton Meter (nm) or 8.8 inch-pounds (lb-in)
Clamp against package body	12.3 kilogram-force per square centimeter (kgf/cm²) or 175 lbf/in²

### **Footprint and Solder Pad Dimensions**

# Pad Dimensions in mm: TO-263AB



**Soldering time and temperature:** This product has been designed for use with high-temperature, lead-free solder. The component leads can be subjected to a maximum temperature of 300 °C, for up to 10 seconds. See Application Note AN-303, for more details.

### **Ordering Information**

Part Number	Package	Packing
LQA20T300C	TO-220AB	50 units/tube
LQA20B300C	TO-263AB	800 units/reel

The information contained in this document is subject to change without notice.



#### LQA20T300C, LQA20B300C

Revision	Notes	Date
1.4	Released by Qspeed	06/10
1.5	Converted to Power Integrations Document	01/11
1.6	Updated with new Brand Style. Added footprint and solder pad dimension for TO-263AB package.	11/15

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